



April 25, 2019

Parker Hannifin Corporation  
Chomerics Division  
77 Dragon Court  
Woburn, MA 01801 USA  
www.parker.com/chomerics

Re: ParPHorm® S1945-25 Non-Conductive Form-In-Place Gasket

Dear Valued Customer,

We would like to take this opportunity to thank you for your continued support and the confidence that you have placed in Parker Chomerics. In keeping with your needs and requirements in mind, due to the global supply constraints on some raw silicone products, Parker Chomerics has discontinued ParPHorm® S1945-25 Non-Conductive Form-In-Place Gasket due supply interruptions which have threatened our ability to effectively support production going forward.

Parker Chomerics is pleased to offer ParPHorm® 1800 Non-Conductive Form-In-Place Sealing Compound (silicone) and ParPHorm® L1938-45 Non-Conductive Form-In-Place Sealing Compound (fluorosilicone) materials as possible replacement materials for the discontinued S1945-25.

Detailed technical information on these possible replacement form-in-place materials can be found in Parker Chomerics' [CHO-FORM Form-in-Place EMI Gasketing Solutions](#) technical bulletin available here and on our website, [www.parker.com/chomerics](http://www.parker.com/chomerics)

Please contact your Market Sales Specialist or Parker Chomerics Application Engineering if you have any questions regarding this notice or alternate form-in-place gasketing materials.

DISCONTINUED ITEM	RECOMMENDED REPLACEMENT
ParPHorm® S1945-25 Non-Conductive Form-In-Place Gasket (silicone) Part Number: 19-26-1945-0250	ParPHorm® 1800 Non-Conductive Form-In-Place Sealing Compound (silicone) Part Number: 19-26-1938-0200  ParPHorm® L1938-45 Non-Conductive Form-In-Place Sealing Compound (fluorosilicone) Part Number: 19-26-1800-0345

Sincerely,

Brian Flaherty  
Product Manager  
Conductive Compounds  
Parker Hannifin Corporation  
Chomerics Division